

# FAST CMOS 16-BIT BIDIRECTIONAL TRANSCEIVER

## IDT74FCT162H245AT/CT

### **FEATURES:**

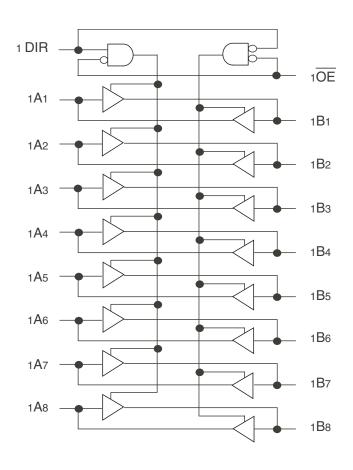
- 0.5 MICRON CMOS Technology
- · High-speed, low-power CMOS replacement for ABT functions
- Typical tsk(o) (Output Skew) < 250ps
- Low input and output leakage ≤ 1µA (max.)
- ESD > 2000V per MIL-STD-883, Method 3015; > 200V using machine model (C = 200pF, R = 0)
- . Bus Hold retains last active bus state during 3-state
- · Eliminates the need for external pull up resistors
- Available in SSOP and TSSOP packages

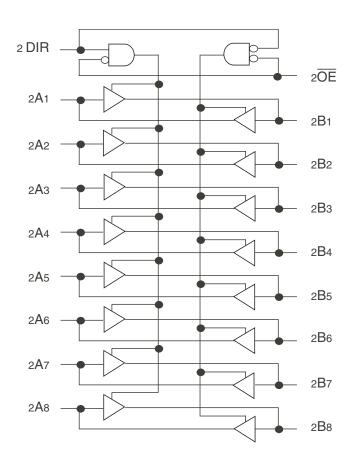
### **DESCRIPTION:**

The FCT162H245T 16-bit transceiver is built using advanced dual metal CMOS technology. These high-speed, low-power transceivers are ideal for synchronous communication between two busses (A and B). The Direction and Output Enable controls operate these devices as either two independent 8-bit transceivers or one 16-bit transceiver. The direction control pin (xDIR) controls the direction of data flow. The output enable pin (x $\overline{OE}$ ) overrides the direction control and disables both ports. All inputs are designed with hysteresis for improved noise margin.

The FCT162H245T has "Bus Hold" which retains the input's last state whenever the input goes to high impedance. This prevents "floating" inputs and eliminates the need for pull-up/down resistors.

### **FUNCTIONAL BLOCK DIAGRAM**





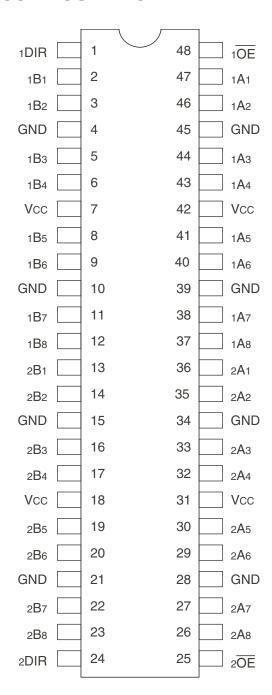
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INDUSTRIAL TEMPERATURE RANGE

SEPTEMBER 2009

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## **PIN CONFIGURATION**



SSOP/ TSSOP TOP VIEW

## **ABSOLUTE MAXIMUM RATINGS**(1)

Symbol	Description	Max	Unit
VTERM <sup>(2)</sup>	Terminal Voltage with Respect to GND	–0.5 to 7	٧
VTERM <sup>(3)</sup>	Terminal Voltage with Respect to GND	-0.5 to Vcc+0.5	V
Tstg	Storage Temperature	-65 to +150	°C
lout	DC Output Current	-60 to +120	mA

#### NOTES:

- 1. Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- All device terminals except FCT162XXXT and FCT166XXT (A-Port) Output and I/O terminals.
- 3. Output and I/O terminals for FCT162XXXT and FCT166XXXT (A-Port).

## **CAPACITANCE** (TA = +25°C, f = 1.0MHz)

Symbol	Parameter <sup>(1)</sup>	Conditions	Тур.	Max.	Unit
CIN	Input Capacitance	VIN = 0V	3.5	6	рF
Соит	Output Capacitance	Vout = 0V	3.5	8	рF

#### NOTE

1. This parameter is measured at characterization but not tested.

### **PIN DESCRIPTION**

Pin Names	Description	
xŌĒ	Outputs Enable Input (Active LOW)	
xDIR	Direction Control Inputs	
xAx	Side A Inputs or 3-State Outputs <sup>(1)</sup>	
xBx	Side B Inputs or 3-State Outputs <sup>(1)</sup>	

#### NOTE:

1. These pins have "Bus-hold". All other pins are standard inputs, outputs, or I/Os.

## **FUNCTION TABLE**(1)

Inputs		
χ <mark>ΘΕ</mark>	xDIR	Output
L	L	Bus B Data to Bus A
L	Н	Bus A Data to Bus B
Н	Х	High Z State

#### NOTE:

- 1. H = HIGH Voltage Level
  - L = LOW Voltage Level
  - X = Don't Care
  - Z = High-Impedance

## DC ELECTRICAL CHARACTERISTICS OVER OPERATING RANGE

Following Conditions Apply Unless Otherwise Specified: Industrial:  $TA = -40^{\circ}C$  to  $+85^{\circ}C$ ,  $VCC = 5.0V \pm 10\%$ 

Symbol	Paramo	Parameter		Test Conditions <sup>(1)</sup>	Min.	Typ. <sup>(2)</sup>	Max.	Unit
VIH	Input HIGH Level		Guaranteed Logic HIGH Level		2	_	_	٧
VIL	Input LOW Level	Input LOW Level		LOW Level		_	0.8	٧
lін	Input	Standard Input <sup>(5)</sup>	Vcc = Max.	VI = VCC		_	±1	μA
	HIGH	Standard I/O <sup>(5)</sup>	]		_	_	±1	
	Current <sup>(4)</sup>	Bus-hold Input	1		_	_	±100	
		Bus-hold I/O	1		_	_	±100	
lıL	Input	Standard Input <sup>(5)</sup>	1	Vı = GND		_	±1	1
	LOW	Standard I/O(5)	1		_	_	±1	
	Current <sup>(4)</sup>	Bus-hold Input	1		_	_	±100	1
		Bus-hold I/O	1		_	_	±100	
Івнн	Bus-hold Sustain	Bus-hold Input	Vcc = Min.	VI = 2V	-50	_	_	μА
İBHL	Current <sup>(4)</sup>			Vı = 0.8V	50	_	_	
lozh	High Impedance O	utput Current	Vcc = Max.	Vo = 2.7V		_	±1	μА
lozL	(3-State Output pin	s) <sup>(5,6)</sup>		Vo = 0.5V		_	±1	
Vıĸ	Clamp Diode Volta	ge	Vcc = Min., IIN = -	-18mA		-0.7	-1.2	٧
los	Short Circuit Current		Vcc = Max., Vo =	: GND <sup>(3)</sup>	-80	-140	-250	mA
VH	Input Hysteresis			_		100	_	mV
ICCL	Quiescent Power Supply Current		Vcc = Max.		-	5	500	μА
Іссн			VIN = GND or Vcc	<u> </u>				
Iccz								

## **OUTPUT DRIVE CHARACTERISTICS**

Symbol	Parameter	Test Condition	Test Conditions <sup>(1)</sup>		Typ. <sup>(2)</sup>	Max.	Unit
IODL	Output LOW Current	$VCC = 5V$ , $VIN = VIH or VIL$ , $VO = 1.5V^{(3)}$		60	115	200	mA
lodh	Output HIGH Current	VCC = 5V, VIN = VIH or VIL, VO = 1.5	$VCC = 5V$ , $VIN = VIH or VIL$ , $VO = 1.5V^{(3)}$		-115	-200	mA
Vон	Output HIGH Voltage	Vcc = Min.	Iон = -24mA	2.4	3.3	_	٧
		VIN = VIH or VIL					
Vol	Output LOW Voltage	Vcc = Min.	IOH = 24mA	_	0.3	0.55	٧
		VIN = VIH or VIL					

#### NOTES

- 1. For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at Vcc = 5.0V, +25°C ambient.
- 3. Not more than one output should be tested at one time. Duration of the test should not exceed one second.
- 4. Pins with Bus-hold are identified in the pin description.
- 5. The test limit for this parameter is  $\pm 5\mu A$  at  $T_A = -55^{\circ}C$ .
- 6. Does not include Bus-hold I/O pins.

### POWER SUPPLY CHARACTERISTICS

Symbol	Parameter	Test Conditi	ons <sup>(1)</sup>	Min.	Typ. <sup>(2)</sup>	Max.	Unit
Δlcc	Quiescent Power Supply Current TTL Inputs HIGH	Vcc = Max. $VIN = 3.4V^{(3)}$		_	0.5	1.5	mA
ICCD	Dynamic Power Supply Current <sup>(4)</sup>	Vcc = Max. Outputs Open xOE = xDIR = GND One Input Toggling 50% Duty Cycle	VIN = VCC VIN = GND	_	60	100	μΑ/ MHz
Ic	Total Power Supply Current <sup>(6)</sup>	Vcc = Max. Outputs Open fi = 10MHz	VIN = VCC VIN = GND	_	0.6	1.5	mA
		50% Duty Cycle  xOE = xDIR = GND  One Bit Toggling	VIN = 3.4V VIN = GND	_	0.9	2.3	
		Vcc = Max. Outputs Open fi = 2.5MHz	VIN = VCC VIN = GND	_	2.4	4.5(5)	
		50% Duty Cycle  xOE = xDIR = GND  Sixteen Bits Toggling	VIN = 3.4V VIN = GND	_	6.4	16.5 <sup>(5)</sup>	

#### NOTES:

- 1. For conditions shown as Min. or Max., use appropriate value specified under Electrical Characteristics for the applicable device type.
- 2. Typical values are at Vcc = 5.0V, +25°C ambient.
- 3. Per TTL driven input (VIN = 3.4V). All other inputs at Vcc or GND.
- 4. This parameter is not directly testable, but is derived for use in Total Power Supply Calculations.
- 5. Values for these conditions are examples of the lcc formula. These limits are guaranteed but not tested.
- 6. IC = IQUIESCENT + INPUTS + IDYNAMIC
  - $IC = ICC + \Delta ICC DHNT + ICCD (fCPNCP/2 + fiNi)$
  - Icc = Quiescent Current (IccL, IccH and Iccz)
  - $\Delta Icc$  = Power Supply Current for a TTL High Input (VIN = 3.4V)
  - DH = Duty Cycle for TTL Inputs High
  - NT = Number of TTL Inputs at DH
  - ICCD = Dynamic Current caused by an Input Transition Pair (HLH or LHL)
  - fcP = Clock Frequency for Register Devices (Zero for Non-Register Devices)
  - NCP = Number of Clock Inputs at fCP
  - fi = Input Frequency
  - Ni = Number of Inputs at fi

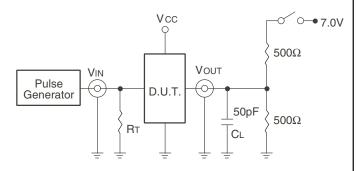
## **SWITCHING CHARACTERISTICS OVER OPERATING RANGE**

			FCT162	H245AT	FCT162	H245CT	
Symbol	Parameter	Condition <sup>(1)</sup>	Min. <sup>(2)</sup>	Max.	Min. <sup>(2)</sup>	Max.	Unit
tPLH tPHL	Propagation Delay A to B, B to A	$CL = 50pF$ $RL = 500\Omega$	1.5	4.6	1.5	3.5	ns
tPZH tPZL	Output Enable Time xOE to A or B		1.5	6.2	1.5	4.4	ns
tPHZ tPLZ	Output Disable Time xOE to A or B		1.5	5	1.5	4	ns
tpzh tpzl	Output Enable Time xDIR to A or B <sup>(3)</sup>		1.5	6.2	1.5	4.8	ns
tPHZ tPLZ	Output Disable Time xDIR to A or B <sup>(3)</sup>		1.5	5	1.5	4	ns
tsk(o)	Output Skew <sup>(4)</sup>		_	0.5	_	0.5	ns

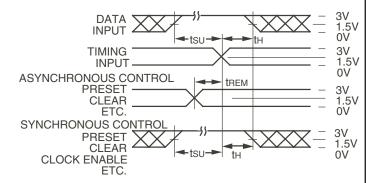
## NOTES:

- 1. See test circuit and waveforms.
- 2. Minimum limits are guaranteed but not tested on Propagation Delays.
- 3. This parameter is guaranteed but not tested.
- 4. Skew between any two outputs, of the same package, switching in the same direction. This parameter is guaranteed by design.

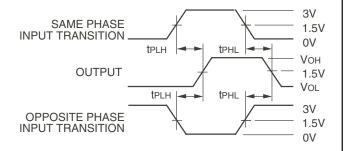
## **TEST CIRCUITS AND WAVEFORMS**



Test Circuits for All Outputs



Set-up, Hold, and Release Times



**Propagation Delay** 

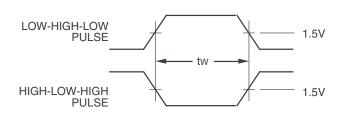
### **SWITCH POSITION**

Test	Switch
Open Drain Disable Low Enable Low	Closed
All Other Tests	Open

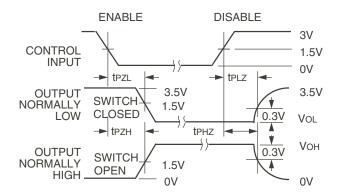
#### **DEFINITIONS:**

CL = Load capacitance: includes jig and probe capacitance.

RT = Termination resistance: should be equal to ZOUT of the Pulse Generator.



Pulse Width

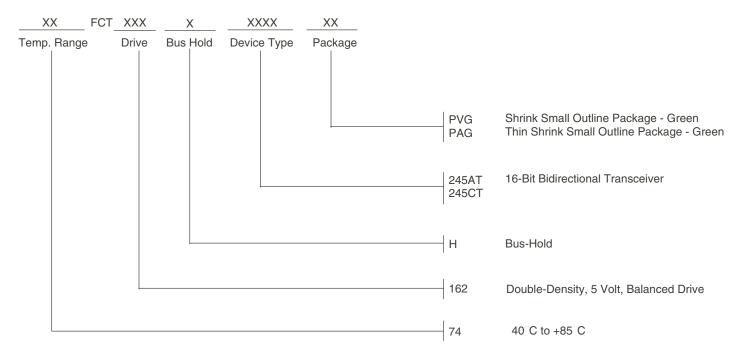


**Enable and Disable Times** 

#### NOTES:

- 1. Diagram shown for input Control Enable-LOW and input Control Disable-HIGH.
- 2. Pulse Generator for All Pulses: Rate  $\leq$  1.0MHz; tF  $\leq$  2.5ns; tR  $\leq$  2.5ns.

## **ORDERING INFORMATION**



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TOYOSU FORESIA, 3-2-24 Toyosu, Koto-ku, Tokyo 135-0061, Japan www.renesas.com

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